

DISTINCTIVE CHARACTERISTICS

Compact Size Combined with High Resolution

- High resolution of 64 x 32 pixels
- 64 colors of backlighting can be controlled dynamically
- Pushbutton switch with LCD, RGB LED backlighting
- General brightness of backlight is dynamically controlled in eight steps from dark to bright
- Operated by commands and data supplied via serial communications (SPI)
- Can display as many as four lines of text with ten characters each
- Incorporates bitmap display function
- Programmable display graphics for alphanumeric characters and animated sequences
- Dual image VRAM for quick change of displayed images
- Low energy consumption
- Dust tight construction

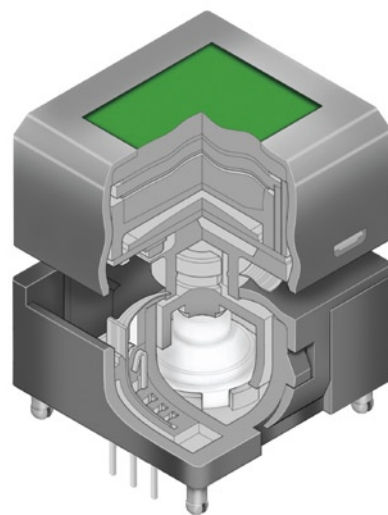
Viewing area: 13.0mm x 10.7mm (horizontal x vertical)

Variety of LED backlighting with 64 colors and 8 steps brightness

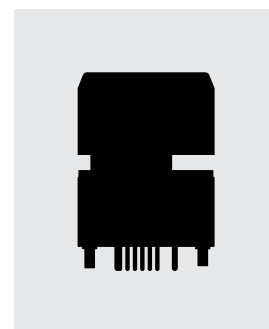
Dome gives crisp tactile feedback to positively indicate circuit transfer

Epoxy sealed straight PC terminals

Snap-in standoff for easy, secure mounting and alignment



Actual Size



DESCRIPTION

Switch Description	LCD Mode	LED Color	LCD/LED
SPST Momentary ON Gold Contacts Straight PC Terminals	Black & White FSTN Positive	Red/Green/Blue	

SWITCH SPECIFICATIONS

Circuit	SPST normally open
Electrical Capacity (Resistive Load)	100mA @ 12V DC
Contact Resistance	200 milliohms maximum @ 20mV 10mA
Insulation Resistance	100 megohms minimum @ 100V DC
Dielectric Strength	125V AC for 1 minute minimum
Mechanical Endurance	1,000,000 operations minimum
Electrical Endurance	1,000,000 operations minimum
Operating Force	1.7 ± 0.5 Newtons
Total Travel	1.8mm (.071")

Absolute Maximum Ratings

Items	Symbols	Ratings
Supply Voltage	V _{DD}	-0.3V to +7.0V
Input Voltage	V _I	-0.3V to V _{DD} +0.3V
Output Voltage	V _O	-0.3V to V _{DD} +0.3V

Optical Characteristics (Temperature at 25°C)

Items	Symbols	Min	Typical	Max
Contrast Ratio	Cr	—	3.0	—
Viewing Angle (Cr ≥ 1.1)	Up & Down	θ	90°	—
	Right & Left	φ	90°	—

BLOCK DIAGRAM & PIN CONFIGURATIONS



Compact High Resolution
SMARTSWITCH™ with RGB LED and
Black and White LCD Mode

LCD SPECIFICATIONS

Characteristics of Display

Display Operation Mode	FSTN positive; background colors, black & white
Display Condition	Transflective with built-in LED backlight
Viewing Angle Direction	6 o'clock
Viewing Area	13.0mm x 10.7mm (horizontal x vertical)
Pixel Format	64 x 32 pixels (horizontal x vertical)
Pixel Size	0.18mm x 0.24mm (horizontal x vertical)
* Operating Temp Range	-15°C ~ +50°C (+5°F ~ +122°F)
Storage Temp Range	-20°C ~ +60°C (-4°F ~ +140°F)
Backlight LED	RGB: red/green/blue

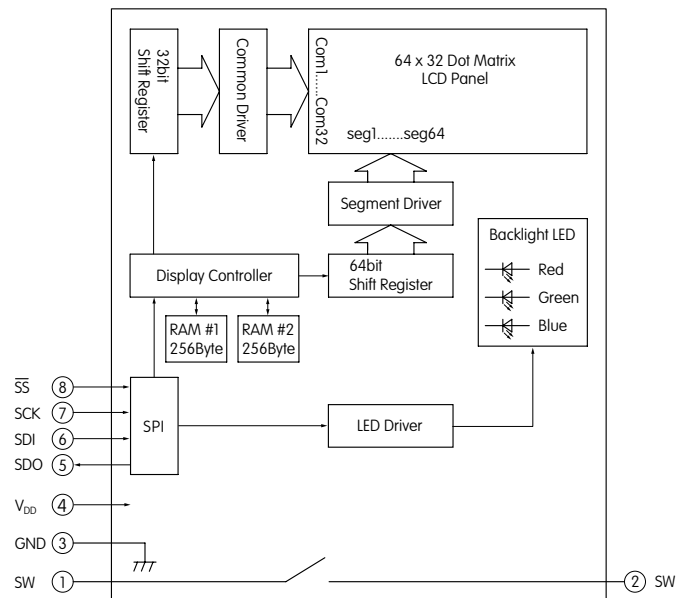
* In a low temperature environment (below 0°C), speed and contrast decrease when image changes. The non-indicator dot may become dense in a high temperature environment (about +50°C).

Recommended Operating Conditions

Items	Symbols	Min	Typical	Max
Supply Voltage	V _{DD}	4.9V	5.0V	5.1V
Input Voltage	V _I	0V	—	V _{DD}
SPI Clock Frequency	f _{SCK}	—	—	8MHz
Current Consumption	I _{DD}	** 10mA	—	*** 50mA

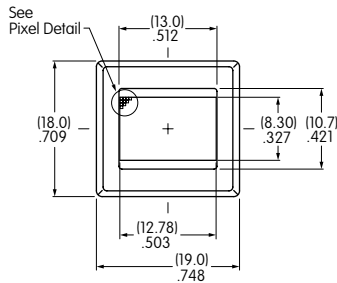
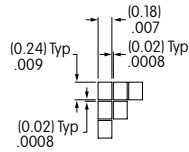
** 10mA: Backlighting LED is off

*** 50mA: Backlighting LEDs (Red, Green, Blue) are maximum brightness

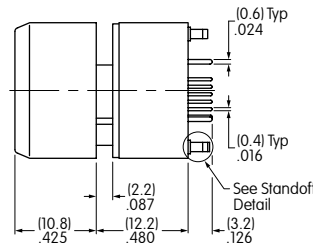
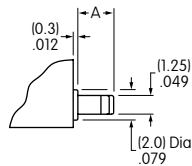


Pin No.	Symbol	Name	Function
①	SW	Terminal of Switch	Normally open
②	SW	Terminal of Switch	Normally open
③	GND	Ground	
④	V _{DD}	Power	Power source for logic circuit and LCD
⑤	SDO	Data Out	Data output line for SPI
⑥	SDI	Data In	Data input line for SPI
⑦	SCK	Serial Clock	Clock line for SPI that synchronizes commands and data
⑧	SS	Slave Select	Chip select for SPI; line is active low

TYPICAL SWITCH DIMENSIONS



Pixel Detail

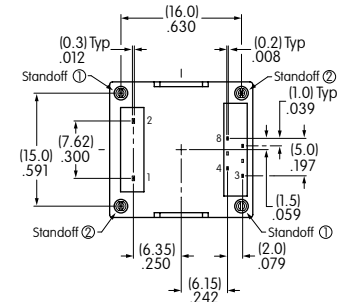
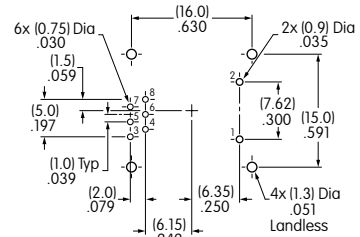


Standoff Detail

Dimension A

Standoff 1 = (2.7) .106 Standoff 2 = (2.3) .091

Terminal numbers are not on the switch.



Footprint

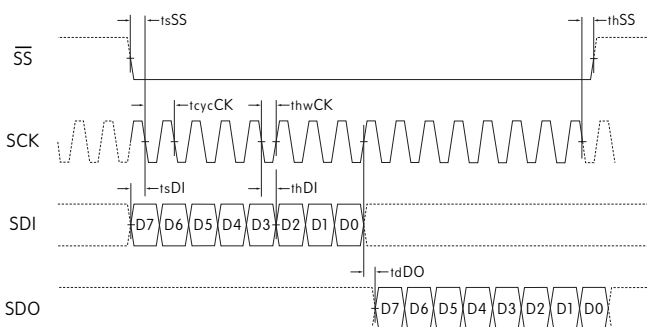
TIMING SPECIFICATIONS

SPI Characteristics (See Timing Diagram)

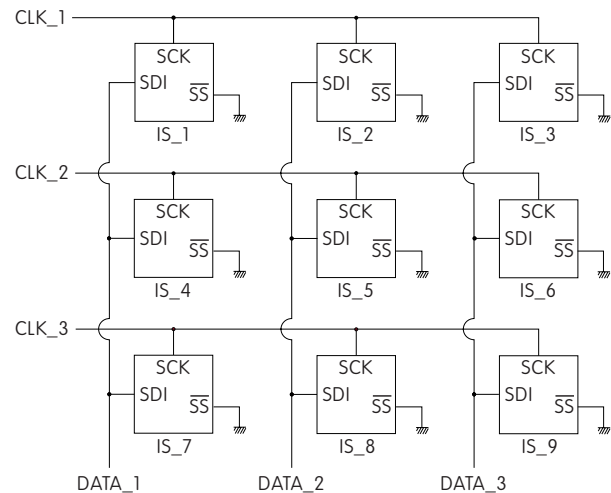
(Temperature at -15°C ~ +50°C and $V_{DD} = 5.0V \pm 2\%$)

Items	Symbols	Minimum	Maximum
SPI $\overline{SS}$ Set Up Time	t_{sSS}	10ns	
SPI $\overline{SS}$ Hold Time	t_{hSS}	10ns	
SPI_CLK Cycle	t_{cycCK}		8MHz
SPI_CLK Width	t_{hwCK}	10ns	
SPI_DI Set Up Time	t_{sDI}	10ns	
SPI_DI Hold Time	t_{hDI}	10ns	
SPI_DO Delay Time	t_{dDO}	10ns	

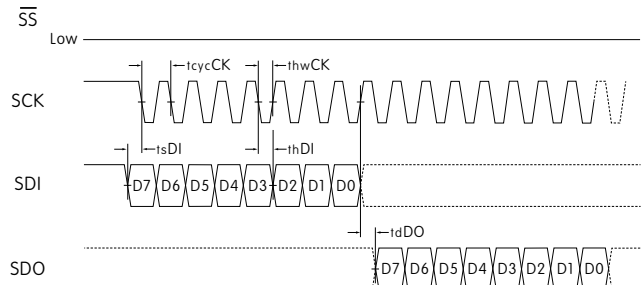
SPI Timing Chart ($\overline{SS}$ Using)



Circuit Example



SPI Timing Chart ($\overline{SS}$ Low Level Fixed)



SDI and SCK shall be kept high when idle.

Segment

Transferring Display Data/Displaying LCD Command and Data Sequence

Notes: Display RAM has two screen areas. The first area is for the display on current LCD; the second area is for the data to be displayed next. The screens are changed when the second area is fully stored.

- Transferring display data/displaying on LCD: command (1 Byte) + data (256 Bytes)
- Others: command (1 Byte) + data (1 Byte)
- Commands can be accepted only when all bits coincide; otherwise, they are not acknowledged
- Additional commands will not be received until the communication of commands (1 Byte) and data (256 or 1 Byte) is completed
- There is no time limit from the beginning to end of data receipt
- Commands may be executed consecutively (no need to wait between commands)
- Irregular commands or data are not recognized
- Initial status at power activation: LCD display off, LED off (brightness 1/20, color off)

LED (Backlight) Color Set

LED (Backlight) Brightness Set

Reset (Returning to Initial Status at Power Activation)

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PRECAUTIONS FOR HANDLING & STORAGE OF LCD DEVICES



Handling

1. The IS Series devices are electrostatic sensitive.
2. Limit operating force to keytop to 100.0N maximum, as excessive pressure may damage the LCD device.
3. The IS series devices are not process sealed.
4. If the LCD is accidentally broken, avoid contact with the liquid and wash off any liquid spills to the skin or clothing.
5. Clean cap surface with dry cloth. If further cleaning is needed, wipe with dampened cloth using neutral cleanser and dry with clean cloth. Do not use organic solvent.
6. Recommended soldering time and temperature limits: 5 seconds maximum @ 270°C maximum
7. Do not exceed 60°C at the LCD level.

Storage

1. Store in original container and away from direct sunlight.
2. Keep away from static electricity.
3. Avoid extreme temperatures, high humidity, gaseous substances, and all forms of chemical contamination.